

PRODUCT / PROCESS CHANGE NOTICE (PCN)					
PCN Number: 16-07	Means of Distinguishing Changed Devices:				
Date Issued: May 24, 2016	Product Mark (See below)				
Product(s) Affected: See below	Back Mark				
Manufacturing Location Affected: N/A	Date Code: The prefix "Z" in the date code.Other:				
Date Effective: August 31, 2016					
Date Effective. August 51, 2010					
Contact: Raul Aman	Attachment: 🖾 Yes; 🗌 No				
Title: Quality Assurance Director	1. Characterization report				
Phone: (408) 435-0800 Fax: (408)435-1100	2. Datasheet				
EMails: PCN_PDN@pericom.com					
Description and Purpose of Change:	Die Technology				
Pericom would like to notify all customers that the die	Wafer Fabrication				
revision of below parts will be upgraded to support	Assembly Process				
broader application.	Equipment				
The datasheet specification was changed as following:	Material: New Die				
1. Adding VDD: 1.8V supporting					
 Decrease ICC operating current from 0.8mA to 0.5mA @ 3.3V 	Manufacturing Site				
	Data Sheet:				
Customers can request samples if they want to verify it's compatibility in their design and to qualify this new version.	Other:				
At the end of 90 day notice, customer should expect to receice inventory from both old and new die until we deplete our old die inventory.					
Affected parts: Pericom Part Number PI3V312LE PI3V312LEX PI3V312QE PI3V312QEX					





Customer Acknowledgement of Receipt:						
Customer:		Date:	Date:			
Name:		eMail:	eMail:			
Title:			Phone:	Phone:		
Approval for shipments prior to effective date Customer Comments (Optional):						
Pericom Internal Use Only:						
Location:	PSC	🖾 PTI	PSE-TW	PSE-SD		
PSETW PCN: N/A						